

Excellent Integrated System Limited

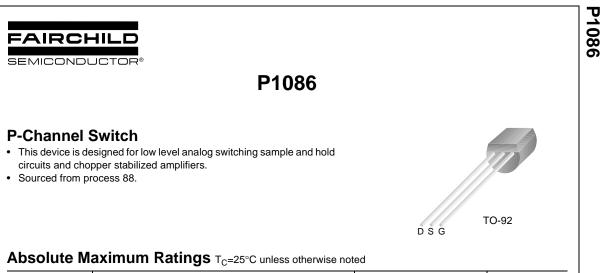
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Fairchild Semiconductor P1086

For any questions, you can email us directly: <u>sales@integrated-circuit.com</u>





Symbol	Parameter	Value	Units
V _{DG}	Drain-Gate Voltage	- 30	V
V _{GS}	Gate-Source Voltage	30	V
I _{GF}	Forward Gate Current	50	mA
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 ~ +150	°C

NOTES:

These ratings are based on a maximum junction temperature of 150 degrees C.
 These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Electrical Characteristics T_C=25°C unless otherwise noted

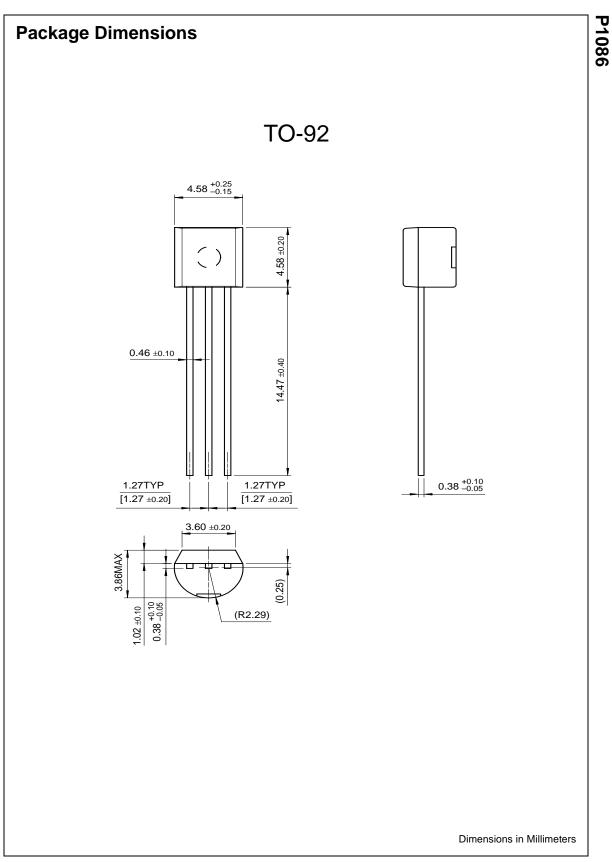
Symbol	Parameter	Test	Condition	Min.	Тур.	Max.	Units
BV _{GSS}	Gate-Source Breakdown Voltage	V _{DS} = 0V, IG =	$V_{DS} = 0V$, IG = 1 μ A				V
I _{GSS}	Gate Reverse Current	V _{GS} = 15V	V _{GS} = 15V			2	nA
I _D (off)	Drain Cutoff Leakage Current	V _{DS} = 15V				10	nA
		$V_{GS} = 12V$	T = +85°C			0.5	μA
I _{DGO}	Drain-Gate Leakage Current $V_{DG} = 15V$ I _S = 0	V _{DG} = 15V				2	NA
200		I _S = 0	T = +85°C			0.1	μA
I _{DSS}	Zero-Gate Voltage Drain Current	V _{DS} = 20V, V _C	$V_{DS} = 20V, V_{GS} = 0V$				mA
V _{GS} (off)	Gate-Source Cutoff Voltage	V _{DS} = 15V, I _D	$V_{DS} = 15V, I_{D} = 1\mu A$			10	V
V _{DS} (on)	Drain-Source On Voltage	V _{GS} = 0V, I _D =	$V_{GS} = 0V, I_D = 6mA$			0.5	V
r _{DS} (on)	Drain-Source On Resistance	$V_{GS} = 0V, I_D = 1mA$				75	Ω
r _{ds} (on)	Drain-Source On Resistance	$V_{GS} = 0V, I_D = 0, f = 1kHz$				75	Ω
C _{iss}	Input Capacitance	V _{DS} = 15V, V _C	V _{DS} = 15V, V _{GS} = 0V, f = 1MHz			45	pF
C _{rss}	Reverse Transfer Capacitance	$V_{DS} = 0V, V_{GS}$	V _{DS} = 0V, V _{GS} = 12V, f = 1MHz			10	pF
t _d (on)	Trun On Time	$V_{DD} = -6V$	$V_{DD} = -6V$ $V_{GS}(off) = +12V$ $R_{L} = 910\Omega$			15	ns
t _r	Rise Time					20	ns
t _d (off)	Trun Off Time	-				15	ns
t _f	Fall Time	$I_{D}(on) = 6mA$				50	ns

Thermal Characteristics TA=25°C unless otherwise noted

Symbol	Parameter	Max.	Units
PD	Total Device Dissipation		mW
	Derate above 25°C	2.8	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	125	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

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Rev. A2, November 2002



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